

L Number	Hits	Search Text	DB	Time stamp
-	350680	438/\$.ccls. or 257/\$.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 22:30
-	2730	(438/\$.ccls. or 257/\$.ccls.) and (metal same (reform\$3 or reflow\$3 or melt\$3 or coagulat\$3)) same ((contact adj hole) or via or trench)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 23:42
-	1355	((438/\$.ccls. or 257/\$.ccls.) and (metal same (reform\$3 or reflow\$3 or melt\$3 or coagulat\$3)) same ((contact adj hole) or via or trench)) and (heat\$3 same metal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 23:33
-	321	((438/\$.ccls. or 257/\$.ccls.) and (metal same (reform\$3 or reflow\$3 or melt\$3 or coagulat\$3)) same ((contact adj hole) or via or trench)) and (heat\$3 same metal) and (circuit same board)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 23:33
-	153	((438/\$.ccls. or 257/\$.ccls.) and (metal same (reform\$3 or reflow\$3 or melt\$3 or coagulat\$3)) same ((contact adj hole) or via or trench)) and (heat\$3 same metal) and (circuit same board) and (first near10 metal) and (second near10 metal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 22:44
-	1	((438/\$.ccls. or 257/\$.ccls.) and (metal same (reform\$3 or reflow\$3 or melt\$3 or coagulat\$3)) same ((contact adj hole) or via or trench)) and (heat\$3 same metal) and (circuit same board) and (first near10 metal) and (second near10 metal) and coagulat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 22:35
-	24	((438/\$.ccls. or 257/\$.ccls.) and (metal same (reform\$3 or reflow\$3 or melt\$3 or coagulat\$3)) same ((contact adj hole) or via or trench)) and (heat\$3 same metal) and (circuit same board) and ((first near10 metal) and (second near10 metal) same fill\$3 same ((contact adj hole) or via or trench))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 23:33
-	6798	((438/597) or (438/598) or (438/614) or (438/615) or (438/618) or (438/652) or (438/658) or (438/660) or (438/666) or (438/667) or (438/669) or (438/672)).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 23:32
-	272	((438/597) or (438/598) or (438/614) or (438/615) or (438/618) or (438/652) or (438/658) or (438/660) or (438/666) or (438/667) or (438/669) or (438/672)).CCLS.) and (metal same (reform\$3 or reflow\$3 or melt\$3 or coagulat\$3)) same ((contact adj hole) or via or trench)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 23:33
-	150	((438/597) or (438/598) or (438/614) or (438/615) or (438/618) or (438/652) or (438/658) or (438/660) or (438/666) or (438/667) or (438/669) or (438/672)).CCLS.) and (metal same (reform\$3 or reflow\$3 or melt\$3 or coagulat\$3)) same ((contact adj hole) or via or trench)) and (heat\$3 same metal)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 23:33

-	27	(((((438/597) or (438/598) or (438/614) or (438/615) or (438/618) or (438/652) or (438/658) or (438/660) or (438/666) or (438/667) or (438/669) or (438/672)).CCLS.) and (metal same (reform\$3 or reflow\$3 or melt\$3 or coagulat\$3)) same ((contact adj hole) or via or trench)) and (heat\$3 same metal)) and (circuit same board)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 23:33
-	3	(((((438/597) or (438/598) or (438/614) or (438/615) or (438/618) or (438/652) or (438/658) or (438/660) or (438/666) or (438/667) or (438/669) or (438/672)).CCLS.) and (metal same (reform\$3 or reflow\$3 or melt\$3 or coagulat\$3)) same ((contact adj hole) or via or trench)) and (heat\$3 same metal)) and (circuit same board)) and ((first near10 metal) and (second near10 metal) same fill\$3 same ((contact adj hole) or via or trench))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 23:41
-	281	((((438/597) or (438/598) or (438/614) or (438/615) or (438/618) or (438/652) or (438/658) or (438/660) or (438/666) or (438/667) or (438/669) or (438/672)).CCLS.) and (Bi or bismuth)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 23:41
-	203	((((438/597) or (438/598) or (438/614) or (438/615) or (438/618) or (438/652) or (438/658) or (438/660) or (438/666) or (438/667) or (438/669) or (438/672)).CCLS.) and (Bi or bismuth)) and (cu or copper)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 23:42
-	30	(((((438/597) or (438/598) or (438/614) or (438/615) or (438/618) or (438/652) or (438/658) or (438/660) or (438/666) or (438/667) or (438/669) or (438/672)).CCLS.) and (Bi or bismuth)) and (cu or copper)) and (metal same (reform\$3 or reflow\$3 or melt\$3 or coagulat\$3)) same ((contact adj hole) or via or trench)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 23:42
-	18	(((((438/597) or (438/598) or (438/614) or (438/615) or (438/618) or (438/652) or (438/658) or (438/660) or (438/666) or (438/667) or (438/669) or (438/672)).CCLS.) and (Bi or bismuth)) and (cu or copper)) and (metal same (reform\$3 or reflow\$3 or melt\$3 or coagulat\$3)) same ((contact adj hole) or via or trench)) and (plating or plated)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 23:42
-	12	(((((438/597) or (438/598) or (438/614) or (438/615) or (438/618) or (438/652) or (438/658) or (438/660) or (438/666) or (438/667) or (438/669) or (438/672)).CCLS.) and (Bi or bismuth)) and (cu or copper)) and (metal same (reform\$3 or reflow\$3 or melt\$3 or coagulat\$3)) same ((contact adj hole) or via or trench)) and (plating or plated)) and (Sn or Ag or indium or Zn or Sb)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 23:43